# Super Fast Recovery Diode

RFN20TJ6S Data Sheet

#### Series

Standard Fast Recovery

# Application

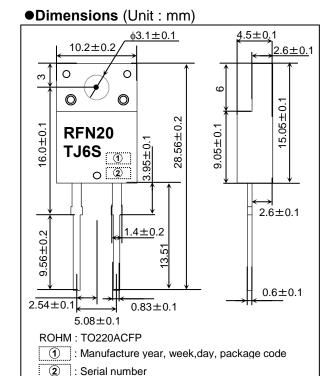
General rectification

#### Features

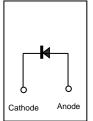
- 1) Low forward voltage
- 2) Low switching loss
- 3) High current overload capacity

#### Construction

Silicon epitaxial planar type



#### Structure



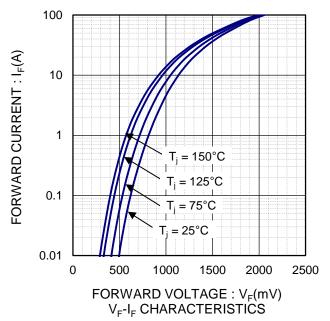
## ● Absolute Maximum Ratings (T<sub>c</sub>= 25°C)

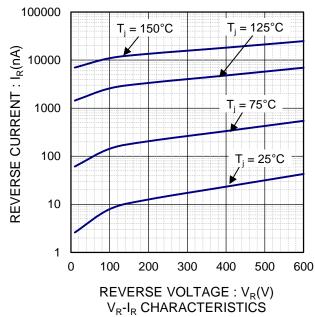
| Parameter                            | Symbol           | Conditions   |                      | Limits      | Unit |
|--------------------------------------|------------------|--|----------------------|-------------|------|
| Repetitive peak reverse voltage      | $V_{RM}$         | Duty≦0.5   |                      | 600         | V    |
| Reverse voltage                      | $V_R$            | Direct reverse voltage                                       |                      | 600         | V    |
| Average current                      | I <sub>o</sub>   | 60Hz half sin wave , resistive load                          | T <sub>c</sub> =50°C | 20          | Α    |
| Non-repetitive forward surge current | I <sub>FSM</sub> | 60Hz half sin wave, one cycle, non-repetitive at $T_j$ =25°C |                      | 150         | Α    |
| Operating junction temperature       | $T_{j}$          | -  |                      | 150         | °C   |
| Storage temperature                  | $T_{stg}$        | -  |                      | -55 to +150 | °C   |

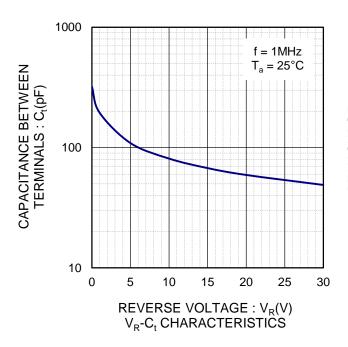
# ●Electrical Characteristics (T<sub>j</sub> = 25°C)

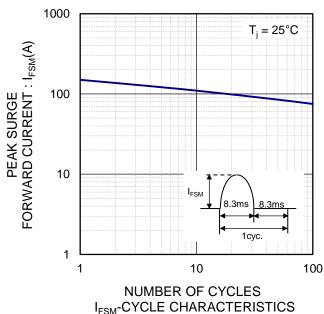
| Parameter                | Symbol                | Conditions   |                       | Min. | Тур. | Max. | Unit |
|--------------------------|-----------------------|--|-----------------------|------|------|------|------|
| Forward voltage          | V <sub>F</sub>        | I <sub>F</sub> =20A                                | T <sub>j</sub> =25°C  | 1.0  | 1.25 | 1.55 | V    |
|                          |                       |  | T <sub>j</sub> =125°C | -    | 1.1  | -    | V    |
| Reverse current          | I <sub>R</sub>        | V <sub>R</sub> =600V                               | T <sub>j</sub> =25°C  | -    | 0.1  | 10   | μΑ   |
|                          |                       |  | T <sub>j</sub> =125°C | •    | 7    | 200  | μΑ   |
| Reverse recovery time    | trr                   | $I_F=0.5A$ , $I_R=1A$ , $Irr=0.25 \times I_R$      |                       | •    | 40   | 60   | ns   |
|                          |                       | $I_F$ =20A, $V_R$ =400V, $dI_F/dt$ =-100A/ $\mu$ s |                       | -    | 85   | 140  | ns   |
| Forward recovery time    | tfr                   | I <sub>F</sub> =20A, dI <sub>F</sub> /dt=100A/μs,  |                       | -    | 300  | -    | ns   |
| Forward recovery voltage | $V_{Fp}$              | $V_{FR}=1.1xV_{Fmax}$                              |                       | -    | 3.2  | -    | V    |
| Thermal resistance       | R <sub>th</sub> (j-a) | Junction to ambient                                |                       | -    | 1    | 7.5  | °C/W |
|                          | R <sub>th</sub> (j-c) | Junction to case                                   |                       | -    | -    | 2.5  | °C/W |

#### **•**Electrical Characteristic Curves

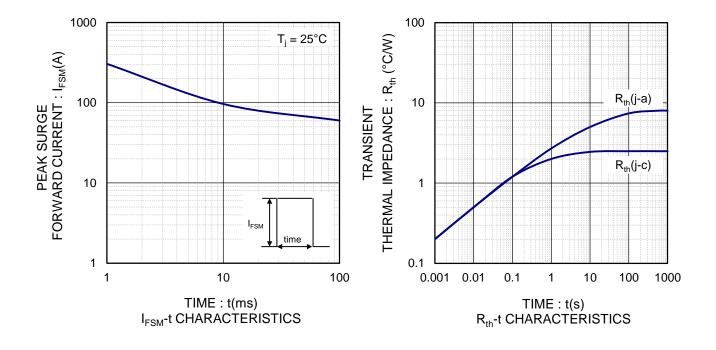


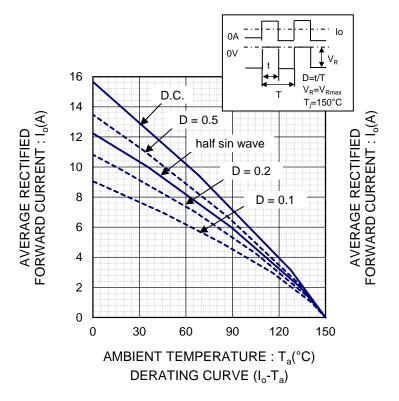


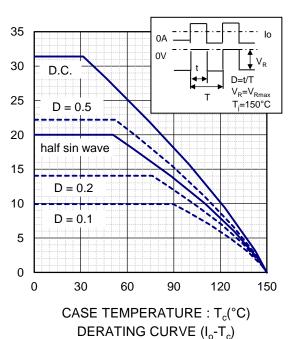




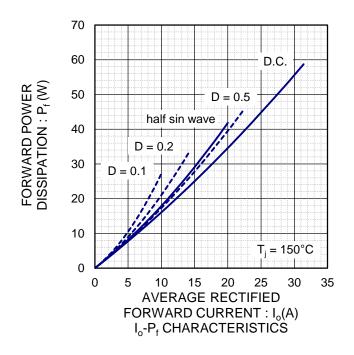
#### •Electrical characteristic curves

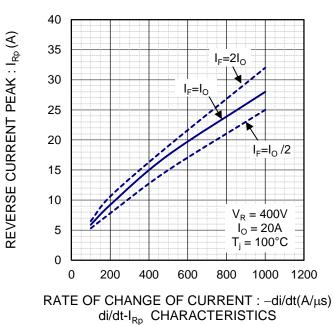




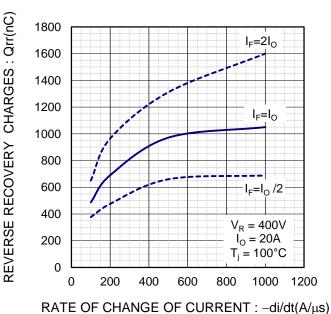


### •Electrical characteristic curves



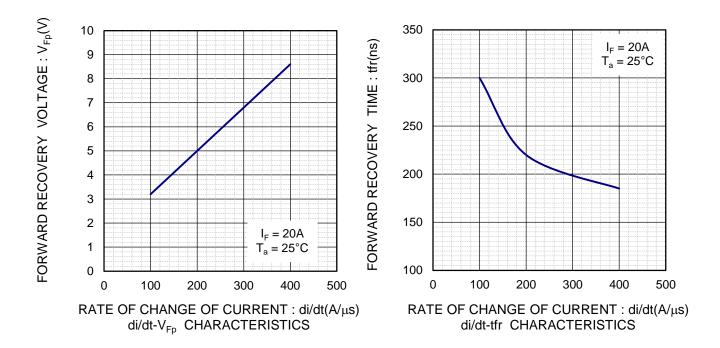


250 REVERSE RECOVERY TIME: trr(ns) V<sub>R</sub> = 400V  $I_{O} = 20A$  $T_i = 100^{\circ}C$ 200 150  $I_F=2I_O$ 100 50  $I_F = I_O / 2$ 0 1000 1200 0 200 400 600 800 RATE OF CHANGE OF CURRENT: -di/dt(A/µs) di/dt-trr CHARACTERISTICS



di/dt-Qrr CHARACTERISTICS

## •Electrical characteristic curves



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|---------|----------|------------|-----------|
| CLASSⅢ  | CLASSⅢ   | CLASS II b | CL ACCIII |
| CLASSIV | CLASSIII | CLASSⅢ     | CLASSIII  |

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  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### **Precaution for Storage / Transportation**

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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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